

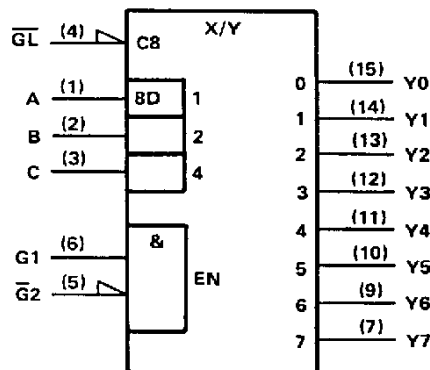
- Combines Decoder and 3-Bit Address Latch
- Incorporates 2 Output Enables to Simplify Cascading
- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs
- Dependable Texas Instruments Quality and Reliability

### description

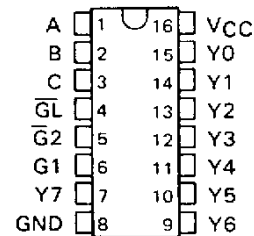
The 'HC237 is a three-line to eight-line decoder/demultiplexer with latches on the three address inputs. When the latch-enable ( $\overline{GL}$ ) is low, the 'HC237 acts as a decoder/demultiplexer. When  $\overline{GL}$  goes from low to high, the address present at the select inputs (A, B, and C) is stored in the latches. Further address changes are ignored as long as  $\overline{GL}$  remains high. The output enable controls, G1 and  $\overline{G2}$ , control the outputs independently of the select or latch-enable inputs. All of the outputs are forced low if G1 is low or  $\overline{G2}$  is high. The 'HC237 is ideally suited for implementing glitch-free decoders in strobed (stored-address) applications in bus-oriented systems.

The SN54HC237 is characterized for operation over the full military temperature range of  $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ . The SN74HC237 is characterized for operation from  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

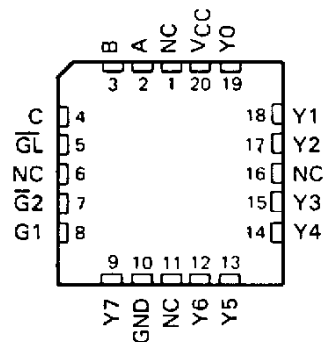
### logic symbols (alternatives)<sup>†</sup>



SN54HC237 . . . J PACKAGE  
 SN74HC237 . . . D<sup>†</sup> OR N PACKAGE  
 (TOP VIEW)



SN54HC237 . . . FK PACKAGE  
 (TOP VIEW)



NC—No internal connection

<sup>†</sup>Contact the factory for D availability.

<sup>†</sup>These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, and N packages.

PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

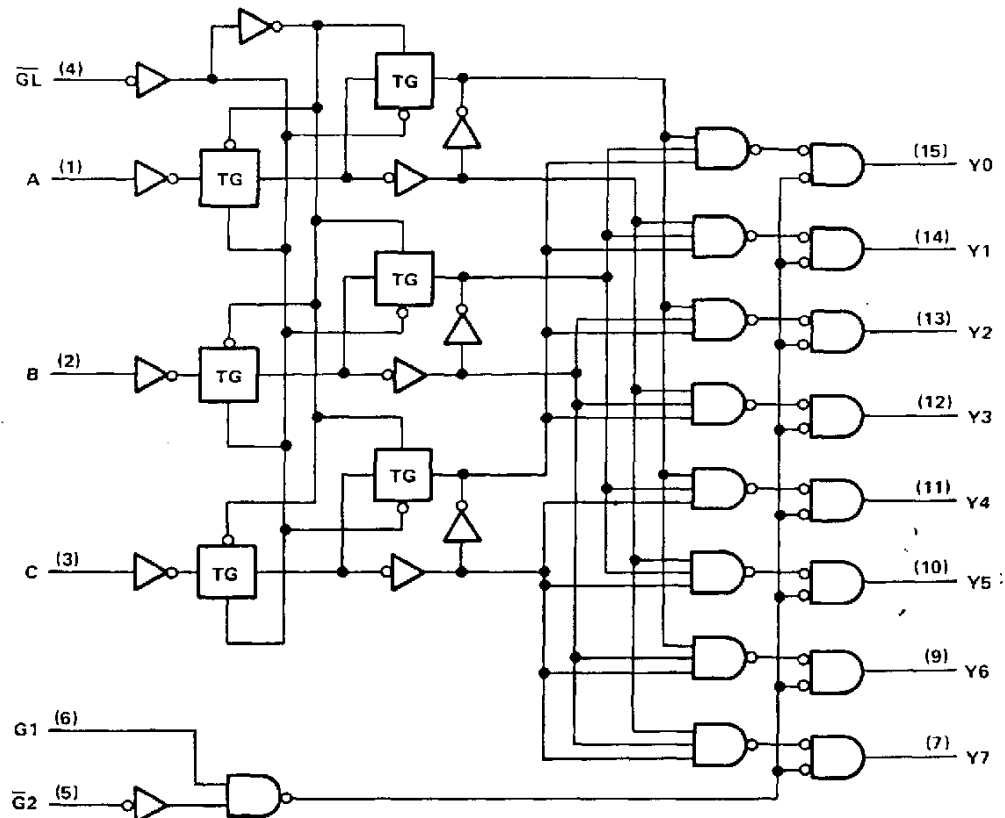
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**SN54HC237, SN74HC237**  
**3-LINE TO 8-LINE DECODERS/DEMULTIPLEXERS**  
**WITH ADDRESS LATCHES**

logic diagram (positive logic)



Pin numbers shown are for D, J, and N packages.

FUNCTION TABLE

INPUTS						OUTPUTS							
ENABLE			SELECT										
GL	G1	G2	C	B	A	Y0	Y1	Y2	Y3	Y4	Y5	Y6	Y7
X	X	H	X	X	X	L	L	L	L	L	L	L	L
X	L	X	X	X	X	L	L	L	L	L	L	L	L
L	H	L	L	L	L	H	L	L	L	L	L	L	L
L	H	L	L	L	H	L	H	L	L	L	L	L	L
L	H	L	L	H	L	L	L	H	L	L	L	L	L
L	H	L	L	H	H	L	L	L	H	L	L	L	L
L	H	L	H	L	L	L	L	L	L	H	L	L	L
L	H	L	H	L	H	L	L	L	L	L	H	L	L
L	H	L	H	H	L	L	L	L	L	L	L	H	L
L	H	L	H	H	H	L	L	L	L	L	L	L	H
H	H	L	X	X	X	Outputs corresponding to stored address, L; all others, H							

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**SN54HC237, SN74HC237**  
**3-LINE TO 8-LINE DECODERS/DEMULTIPLEXERS**  
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**absolute maximum ratings over operating free-air temperature range†**

Supply voltage, $V_{CC}$	-0.5 V to 7 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ )	$\pm 20$ mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ )	$\pm 20$ mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )	$\pm 25$ mA
Continuous current through $V_{CC}$ or GND pins	$\pm 50$ mA
Lead temperature 1,6 mm (1/16 in) from case for 60 s: FK or J package	300°C
Lead temperature 1,6 mm (1/16 in) from case for 10 s: D or N package	260°C
Storage temperature range	-65°C to 150°C

†Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

**recommended operating conditions**

			SN54HC237			SN74HC237			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V <sub>CC</sub>	Supply voltage		2	5	6	2	5	6	V
V <sub>IH</sub>	High-level input voltage	V <sub>CC</sub> = 2 V	1.5			1.5			V
		V <sub>CC</sub> = 4.5 V	3.15			3.15			
		V <sub>CC</sub> = 6 V	4.2			4.2			
V <sub>IL</sub>	Low-level input voltage	V <sub>CC</sub> = 2 V	0			0			V
		V <sub>CC</sub> = 4.5 V	0			0			
		V <sub>CC</sub> = 6 V	0			0			
V <sub>I</sub>	Input voltage		0			V <sub>CC</sub>			V
V <sub>O</sub>	Output voltage		0			V <sub>CC</sub>			V
t <sub>t</sub>	Input transition (rise and fall) times	V <sub>CC</sub> = 2 V	0			0			ns
		V <sub>CC</sub> = 4.5 V	0			0			
		V <sub>CC</sub> = 6 V	0			0			
T <sub>A</sub>	Operating free-air temperature		-55			125			°C

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	$V_{CC}$	$T_A = 25^\circ\text{C}$			SN54HC237		SN74HC237		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
$V_{OH}$	$V_I = V_{IH}$ or $V_{IL}$ , $I_{OH} = -20 \mu\text{A}$	2 V	1.9	1.998		1.9		1.9		V
		4.5 V	4.4	4.499		4.4		4.4		
		6 V	5.9	5.999		5.9		5.9		
	$V_I = V_{IH}$ or $V_{IL}$ , $I_{OH} = -4$ mA	4.5 V	3.98	4.30		3.7		3.84		
$V_{OL}$	$V_I = V_{IH}$ or $V_{IL}$ , $I_{OH} = -5.2$ mA	6 V	5.48	5.80		5.2		5.34		V
	$V_I = V_{IH}$ or $V_{IL}$ , $I_{OL} = 20 \mu\text{A}$	2 V		0.002	0.1		0.1		0.1	
		4.5 V		0.001	0.1		0.1		0.1	
		6 V		0.001	0.1		0.1		0.1	
	$V_I = V_{IH}$ or $V_{IL}$ , $I_{OL} = 4$ mA	4.5 V		0.17	0.26		0.4		0.33	
$I_I$	$V_I = V_{IH}$ or $V_{IL}$ , $I_{OL} = 5.2$ mA	6 V		0.15	0.26		0.4		0.33	nA
	$V_I = V_{CC}$ or 0	6 V		$\pm 0.1$	$\pm 100$		$\pm 1000$		$\pm 1000$	
$I_{CC}$	$V_I = V_{CC}$ or 0, $I_O = 0$	6 V			8		160		80	$\mu\text{A}$
$C_i$		2 to 6 V		3	10		10		10	pF

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**SN54HC237, SN74HC237**  
**3-LINE TO 8-LINE DECODERS/DEMULTIPLEXERS**  
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timing requirements over recommended operating free-air temperature range (unless otherwise noted)

	V <sub>CC</sub>	T <sub>A</sub> = 25°C			SN54HC237		SN74HC237		UNIT
		MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>w</sub> Pulse duration, $\overline{GL}$ low	2 V	80			120		100		ns
	4.5 V	16			24		20		
	6 V	14			20		17		
t <sub>su</sub> Setup time, A, B, or C before $\overline{GL}\uparrow$	2 V	75			115		95		ns
	4.5 V	15			23		19		
	6 V	13			20		16		
t <sub>h</sub> Hold time, A, B, and C after $\overline{GL}\uparrow$	2 V	5			5		5		ns
	4.5 V	5			5		5		
	6 V	5			5		5		

switching characteristics over recommended operating free-air temperature range (unless otherwise noted), C<sub>L</sub> = 50 pF (see Note 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub>	T <sub>A</sub> = 25°C			SN54HC237		SN74HC237		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>pd</sub>	A, B, C	Any	2 V		91	190		285		240	ns
			4.5 V		23	38		57		48	
			6 V		17	32		48		41	
t <sub>pd</sub>	$\overline{G}2$	Any	2 V		66	145		220		181	ns
			4.5 V		18	29		44		36	
			6 V		13	25		37		31	
t <sub>pd</sub>	G1	Any	2 V		68	145		220		181	ns
			4.5 V		18	29		44		36	
			6 V		14	25		37		31	
t <sub>pd</sub>	$\overline{GL}$	Any	2 V		92	190		285		240	ns
			4.5 V		24	38		57		48	
			6 V		19	32		48		41	
t <sub>t</sub>		Any	2 V		38	75		110		95	ns
			4.5 V		8	15		22		19	
			6 V		6	13		19		16	

C <sub>pd</sub>	Power dissipation capacitance	No load, T <sub>A</sub> = 25°C	85 pF typ
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NOTE 1: Load circuit and voltage waveforms are shown in Section 1.



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